

# NC2600ZA000A180-EV

### 2A Low Quiescent Current PWM/PFM Step-down Switching Regulator Evaluation Board

No.EEV-ZA000A180-250422

NC2600ZA000A180-EV is the evaluation board for NC2600 which has the below features, benefits and specifications.

### **GENERAL DESCRIPTION**

The NC2600 is a low quiescent current PWM / PFM 2A step-down switching regulator IC using CMOS-based. The NC2600 is available in WLCSP-8-P11 and DFN2020-8-GT, and it is suitable for use in wearable and IoT devices that require miniaturization and long-lifetime of battery.

### **FEATURES**

Input Voltage Range (Maximum Rating): 2.3 V to 5.5 V (6.5 V)

Operating Temperature Range : −40 °C to 85 °C

Output Voltage: 1.8 V
 Feedback Voltage Accuracy: ±9 mV
 Quiescent Current: Typ. 17 µA

Switching Frequency: Typ.4.0 MHz (VSET = 1.8 V)

UVLO Detection Voltage : Typ.2.0 V

Soft-Start Time : Typ. 0.15 ms When CSS is open.
 Thermal Shutdown Function : Detection Temperature Typ. 150 °C Release Temperature Typ. 120 °C

Auto Discharge FunctionLatch Protection Function

 For more details on NC2600 IC, please refer to https://www.nisshinbo-microdevices.co.jp/en/products/dc-dc-switching-regulator/spec/?product=nc2600

### PART NUMBER INFORMATION

| Product Name    | Package     |
|-----------------|-------------|
| NC2600ZA000A180 | WLCSP-8-P11 |

### Description of configuration

|     | Item           | Description                    |
|-----|----------------|--------------------------------|
| 000 | Output Voltage | Adjustable Output Voltage Type |

#### Version

|   | Latch Protection Function | Auto Discharge Function |
|---|---------------------------|-------------------------|
| А | Yes                       | Yes                     |

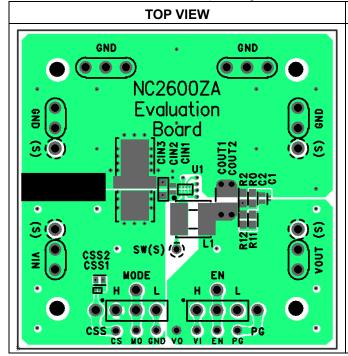
#### Grade

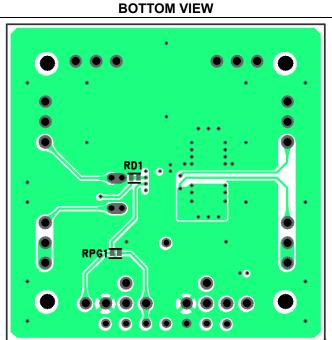
|   | Applications | Operating Temperature Range | Test Temperature |  |
|---|--------------|-----------------------------|------------------|--|
| S | Consumer     | −40 °C to 85 °C             | 25 °C            |  |

180: 1.8 V, Output Voltage

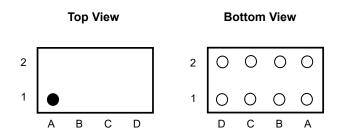
# **PCB LAYOUT**

Evaluation board of NC2600ZA (Package: WLCSP-8-P11)





### **PIN DESCRIPTIONS**



WLCSP-8-P11 Pin Configuration

### NC2600ZA (WLCSP-8-P11) Pin Descriptions

| Pin No. | Pin Name | I/O   | Description   |
|---------|----------|-------|---|
| A1      | VIN      | Power | Power Supply Input Pin  |
| B1      | SW       | 0     | Switching Output Pin Internal MOSFET Drain Connect the inductor between the VOUT node and the SW pin.   |
| C1      | EN       | I     | Enable Pin Can set the active state with the "High" input and the shutdown state with the "Low" input.  |
| D1      | PG       | 0     | Power-good Output Pin NMOS open drain output. In normal operation, "High" (pull-up voltage) is output.  |
| A2      | GND      | -     | Ground Pin  |
| B2      | CSS      | I     | Soft-Start Adjustment Pin Soft-Start time can be adjusted by connecting a capacitor between the CSS pin and GND.  |
| C2      | MODE     | I     | Mode Control Pin High: Forced PWM Control, Low: PWM/PFM Auto Switching Control.   |
| D2      | FB       | I     | Feedback Pin When using NC2600xx000x (adjustable output voltage type), connect an external resistor as the feedback input pin for the error amplifier and set the output voltage. When using the internal fixed output voltage type, connect it to the VOUT node as an output voltage feedback pin. |

For details, refer to "<u>Typical Application Circuit</u>" and " <u>THEORY OF OPERATION</u>".

### **ABSOLUTE MAXIMUM RATINGS**

#### **Absolute Maximum Ratings**

| Parameter                     | Symbol          | Ratings                       | Unit |
|-------------------------------|-----------------|-------------------------------|------|
| Input Voltage                 | V <sub>IN</sub> | -0.3 to 6.5                   | V    |
| SW pin voltage                | Vsw             | −0.3 to V <sub>IN</sub> + 0.3 | V    |
| EN pin voltage                | V <sub>EN</sub> | -0.3 to 6.5                   | V    |
| CSS pin voltage               | Vcss            | -0.3 to 6.5                   | V    |
| PG pin voltage                | V <sub>PG</sub> | -0.3 to 6.5                   | V    |
| MODE pin voltage              | VMODE           | -0.3 to 6.5                   | V    |
| FB pin voltage                | $V_{FB}$        | -0.3 to 6.5                   | V    |
| Junction Temperature Range *1 | Tj              | -40 to 125                    | °C   |
| Storage Temperature Range     | Tstg            | −55 to 125                    | °C   |

#### **ABSOLUTE MAXIMUM RATINGS**

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

Please refer to "THERMAL CHARACTERISTICS" for the thermal resistance under our measurement board conditions

### RECOMMENDED OPERATING CONDITIONS

| Parameter                   | Symbol | Ratings    | Unit |
|-----------------------------|--------|------------|------|
| Input Voltage               | Vin    | 2.3 to 5.5 | V    |
| Operating Temperature Range | Та     | −40 to 85  | °C   |

#### **RECOMMENDED OPERATING CONDITIONS**

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>&</sup>lt;sup>\*1</sup> Calculate the power consumption of the IC from the operating conditions, and calculate the junction temperature with the thermal resistance.

### **ELECTRICAL CHARACTERISTICS**

### NC2600xx000x (Adjustable Output Voltage Type)

 $V_{IN} = 3.6V$  unless otherwise specified.

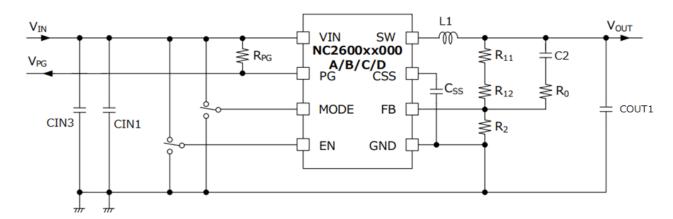
For parameter that do not describe the temperature condition, the MIN / MAX value under the condition of  $-40~^{\circ}\text{C} \le T_a \le 85~^{\circ}\text{C}$  is described.

| Parameter                                 | Symbol             | Conditio   | ns              | MIN   | TYP   | MAX   | Unit |
|---|--------------------|--|-----------------|-------|-------|-------|------|
| Feedback voltage                          | V <sub>FB</sub>    | Ta = 25 °C   |                 | 0.591 | 0.600 | 0.609 | V    |
| Switching Frequency                       | fosc               | V <sub>MODE</sub> =3.6 V                                       |                 | -     | 4.0   | -     | MHz  |
| Quiescent Current                         | ΙQ                 | V <sub>FB</sub> = 0.63 V, V <sub>MODE</sub> = 0 V              | /, no switching | -     | 17    | 25    | μA   |
| Shutdown current                          | I <sub>SD</sub>    | V <sub>IN</sub> = 5.5 V, V <sub>EN</sub> = 0 V                 |                 | -     | 0     | 5     | μA   |
| EN "H" Input Current                      | I <sub>ENH</sub>   | V <sub>IN</sub> = V <sub>EN</sub> = 5.5 V                      |                 | -1    | 0     | 1     | μA   |
| EN "L" Input Current                      | I <sub>ENL</sub>   | V <sub>IN</sub> = 5.5 V, V <sub>EN</sub> = 0 V                 |                 | -1    | 0     | 1     | μA   |
| MODE "H" Input Current                    | I <sub>MODEH</sub> | VIN = VMODE = 5.5 V  |                 | -1    | 0     | 1     | μA   |
| MODE "L" Input Current                    | IMODEL             | V <sub>IN</sub> = 5.5 V, V <sub>MODE</sub> = 0 V               |                 | -1    | 0     | 1     | μA   |
| FB "H" Input Current                      | I <sub>FBH</sub>   | V <sub>IN</sub> = V <sub>FB</sub> = 5.5 V, V <sub>EN</sub> = 0 | ) V             | -1    | 0     | 1     | μA   |
| FB "L" Input Current                      | I <sub>FBL</sub>   | V <sub>IN</sub> = 5.5 V, V <sub>EN</sub> = V <sub>FB</sub> = 0 | ) V             | -1    | 0     | 1     | μA   |
| On-resistance for Discharger              | Rondis             | NC2600xx000A/C   |                 | -     | 60    | -     | Ω    |
| EN pin "H" Input Voltage                  | V <sub>ENH</sub>   | V <sub>IN</sub> = 5.5 V  |                 | 1.0   | -     | -     | V    |
| EN pin "L" Input Voltage                  | VENL               | V <sub>IN</sub> = 2.3 V  |                 | -     | -     | 0.4   | V    |
| MODE "H" Input Voltage                    | V <sub>MODEH</sub> | V <sub>IN</sub> = 5.5 V  |                 | 1.0   | -     | -     | V    |
| MODE "L" Input Voltage                    | V <sub>MODEL</sub> | V <sub>IN</sub> = 2.3 V  |                 | -     | -     | 0.4   | V    |
| On-resistance of High Side<br>MOSFET      | Ronh               | I <sub>SW</sub> = 100 mA                                       | NC2600ZA        | -     | 0.13  | -     | Ω    |
| On-resistance of Low Side MOSFET          | Ronl               | I <sub>SW</sub> = 100 mA                                       | NC2600ZA        | -     | 0.09  | -     | Ω    |
| Soft-Start Time 1                         | tstart1            | CSS = OPEN   |                 | -     | 150   | 300   | μs   |
| Soft-Start Time 2                         | tstart2            | CSS = 0.1 µF   |                 | 15    | 30    | 45    | ms   |
| SW Current Limit                          | Iswlim             |  |                 | 2.3   | -     | 4.7   | Α    |
| Protection Delay Time                     | t <sub>PROT</sub>  | NC2600xx000A/B   |                 | 10    | 20    | 40    | μs   |
| UVLO Detection Voltage *1                 | Vuvlodet           | V <sub>IN</sub> = Falling                                      |                 | 1.85  | 2.00  | 2.20  | V    |
| UVLO Release Voltage *1                   | Vuvlorel           | V <sub>IN</sub> = Rising                                       |                 | 1.90  | 2.05  | 2.25  | V    |
| On resistance at PG "L" Output            | Ronpg              | V <sub>FB</sub> = 0 V  |                 | -     | 45    | -     | Ω    |
| OV Detection Voltage                      | Vovd               | V <sub>FB</sub> = Rising                                       |                 | 0.66  | 0.72  | -     | V    |
| UV Detection Voltage                      | V <sub>UVD</sub>   | V <sub>FB</sub> = Falling                                      |                 | -     | 0.48  | 0.54  | V    |
| Thermal Shutdown Detection<br>Temperature | T <sub>SDDET</sub> | T <sub>j</sub> = Rising  |                 | -     | 150   | -     | °C   |
| Thermal Shutdown Release<br>Temperature   | T <sub>SDREL</sub> | T <sub>j</sub> = Falling                                       |                 | -     | 120   | -     | °C   |

All electrical characteristic parameters that specify the minimum and maximum specifications are tested under the condition of  $T_i \approx T_a = 25$  °C

<sup>&</sup>lt;sup>\*1</sup> Due to the circuit configuration,  $V_{UVLODET} ≥ V_{UVLOREL}$  does not hold. The hysteresis is Typ.0.05 V.

## **TYPICAL APPLICATION CIRCUIT**



**NC2600xx Typical Application Circuit** 

| Recommended Val | lues for cor | nponents |
|-----------------|--------------|----------|
|-----------------|--------------|----------|

|                                | Turistic for Company  |
|--------------------------------|---|
| Symbol                         | Value   |
| CIN3                           | 22 μF * 2set  |
| CIN1                           | 4.7 μF  |
| COUT1                          | 10 μF   |
| L1                             | 1.0 µH  |
| R0                             | 1.0 kΩ  |
| R11                            | 220 kΩ  |
| R12                            | 220 kΩ  |
| R2                             | 220 kΩ  |
| RPG                            | OPEN  |
| CSS                            | OPEN  |
| C2                             | 10 pF   |
| COUT1 L1 R0 R11 R12 R2 RPG CSS | 10 μF<br>1.0 μH<br>1.0 kΩ<br>220 kΩ<br>220 kΩ<br>220 kΩ<br>OPEN<br>OPEN |

### **TECHNICAL NOTES**

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points.

- External components must be connected as close as possible to the ICs and make wiring as short as
  possible and on the same side of the IC. Especially, the capacitor connected in between VIN pin and GND
  pin must be wiring the shortest.
- The VIN line, the GND line, and SW pin should make special considerations for the large switching current flows. If their impedance is high, internal voltage of the IC may shift by the switching current, and the operating may be unstable. Make the power supply and GND lines as wide and short as possible. The wiring from the SW pin to the inductor becomes a noise source, so ensure that the current capacity is secured and that the wiring is not wider or longer than necessary so that the noise does not increase.
- Connect COUT to the wiring between the FB pin and the inductor(L), or between the output voltage setting
  resistor (R1) and L. Also, keep them as far away as possible from noise sources such as inductors to
  prevent noise from being mixed in.
- The thermal shutdown function prevents the IC from fuming and ignition but does not ensure the IC's reliability or keep the IC below the absolute maximum ratings. The thermal shutdown function does not operate on the heat generated by other than the normal IC operation such as latch-up and overvoltage application. The thermal shutdown function operates in a state over the absolute maximum ratings, therefore the thermal shutdown function should not be used for a system design.
- The tab on the bottom side of the DFN-Package is recommended to be connected to GND. It will work even if it is open, but please note that the heat dissipation and mounting strength will decrease.



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